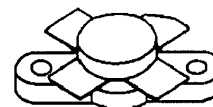


MS1007

RF & MICROWAVE TRANSISTORS HF SSB APPLICATIONS

Features

- 30 MHz
- 50 VOLTS
- $P_{OUT} = 150$ WATTS
- $G_P = 14$ dB MINIMUM
- COMMON EMITTER CONFIGURATION

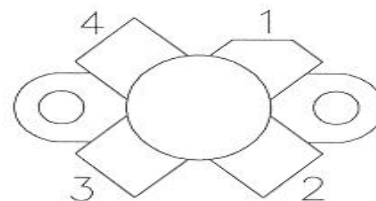


.500 4LFL (M174)
epoxy sealed

DESCRIPTION:

The MS1007 is a 50V epitaxial silicon NPN planar transistor designed primarily for SSB communications. This device utilizes emitter ballasting to achieve extreme ruggedness under severe operating conditions.

PIN CONNECTION



1. Collector 3. Base
2. Emitter 4. Emitter

ABSOLUTE MAXIMUM RATINGS ($T_{case} = 25^{\circ}C$)

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-Base Voltage	110	V
V_{CEO}	Collector-Emitter Voltage	55	V
V_{EBO}	Emitter-Base Voltage	4.0	V
I_C	Device Current	10	A
P_{DISS}	Power Dissipation	233	W
T_J	Junction Temperature	+200	$^{\circ}C$
T_{STG}	Storage Temperature	-65 to +150	$^{\circ}C$

Thermal Data

$R_{TH(J-C)}$	Thermal Resistance Junction-case	0.75	$^{\circ}C/W$
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ELECTRICAL SPECIFICATIONS (T_{case} = 25°C)

STATIC

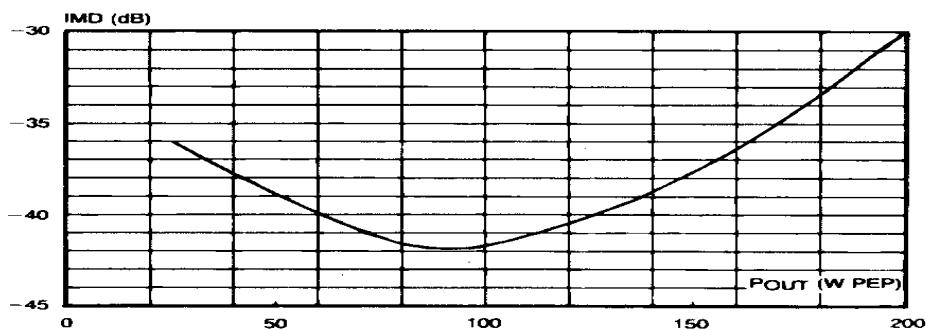
Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
BV_{CBO}	I_C = 100mA I_E = 0mA	110	---	---	V
BV_{CES}	I_C = 100mA V_{BE} = 0V	110	---	---	V
BV_{CEO}	I_C = 100mA I_B = 0mA	55	---	---	V
BV_{EBO}	I_E = 10mA I_C = 0mA	4.0	---	---	V
I_{CEO}	V_{CE} = 30V I_E = 0 mA	---	---	5	mA
I_{CES}	V_{CE} = 60V I_E = 0mA	---	---	5	mA
h_{FE}	V_{CE} = 6V I_C = 1.4A	18	---	43.5	---

DYNAMIC

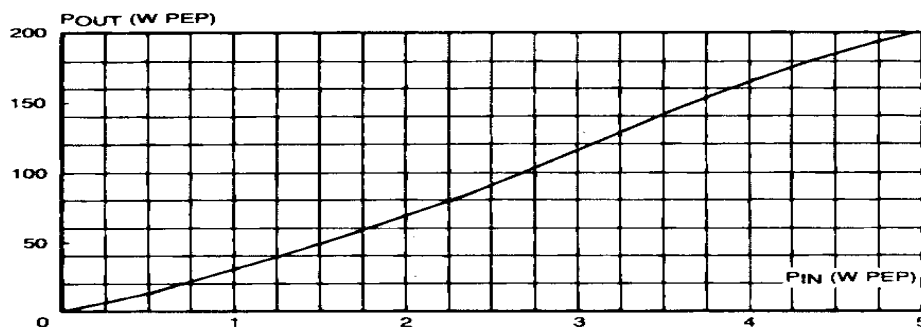
Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
P_{OUT}	f = 30 MHz V_{CE} = 50V I_{CQ} = 100mA	150	---	---	WPEP
G_p	P_{OUT} = 150WPEP V_{CE} = 50V I_{CQ} = 100mA	14	---	---	dB
IMD	P_{OUT} = 150WPEP V_{CE} = 50V I_{CQ} = 100mA	---		-30	dBc
η_C	P_{OUT} = 150WPEP V_{CE} = 50V I_{CQ} = 100mA	37	---	---	%
C_{OB}	f = 1 MHz V_{CB} = 50 V	---	---	220	pf
Conditions	f1 = 30.000MHz f2 = 30.001MHz				

TYPICAL PERFORMANCE

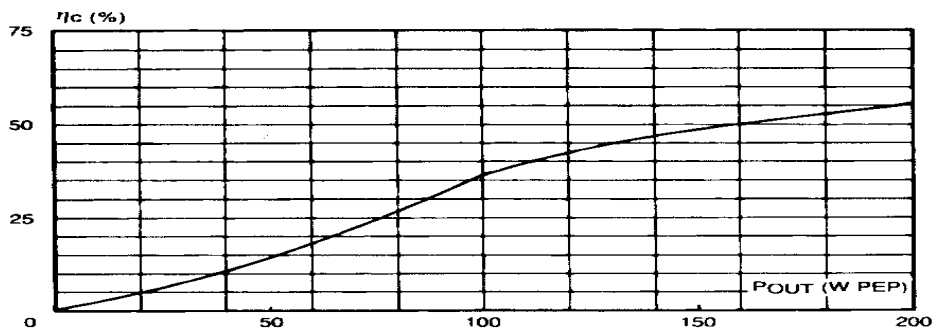
**INTERMODULATION DISTORTION vs POWER
OUTPUT PEP**



POWER OUTPUT PEP vs POWER INPUT

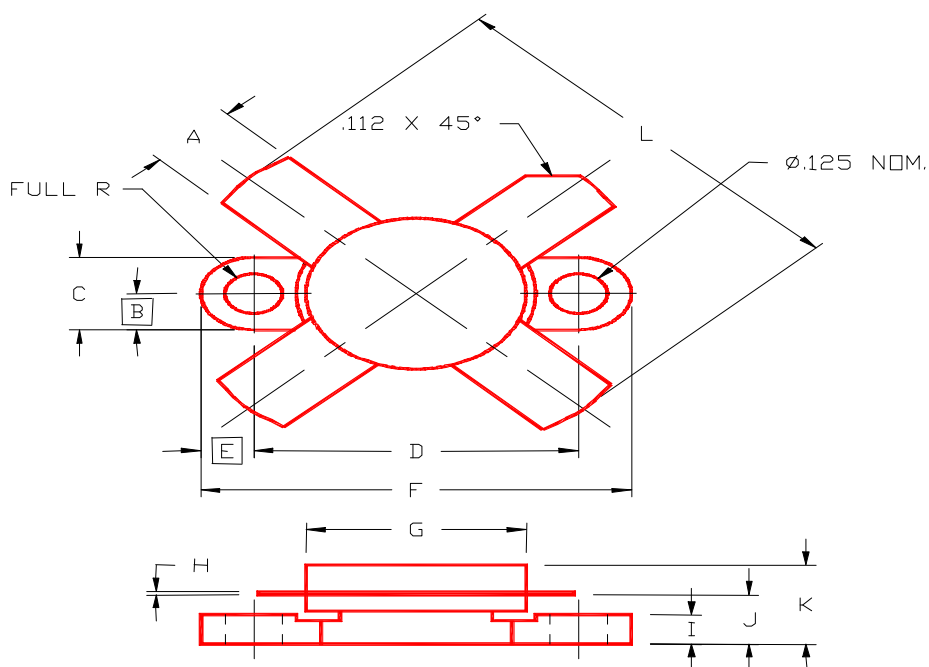


COLLECTOR EFFICIENCY vs POWER OUTPUT PEP



PACKAGE MECHANICAL DATA

PACKAGE STYLE M174



	MINIMUM INCHES/MM	MAXIMUM INCHES/MM		MINIMUM INCHES/MM	MAXIMUM INCHES/MM
A	.220/5,59	.230/5,84	I	.090/2,29	.110/2,79
B	.125/3,18		J	.160/4,06	.175/4,45
C	.245/6,22	.255/6,48	K		.280/7,11
D	.720/18,28	.730/18,54	L		1.050/26,67
E	.125/3,18				
F	.970/24,64	.980/24,89			
G	.495/12,57	.505/12,83			
H	.003/0,08	.007/0,18			